

Features

- Low power consumption
- General purpose leads
- · Bulk, Available on tape and reel
- Fast response time
- High photo sensitivity
- Small junction capacitance
- Compliance with EU REACH
- The product itself remain within RoHS compliant version

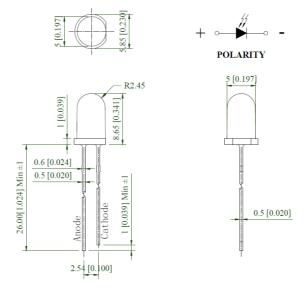
Applications

- High speed photo detector
- Automatic door sensor
- Security system
- Industrial equipment
- Infrared application system

Description

- The INL-5APD80 is a high speed and high sensitive silicon PIN photodiode in a standard 5mm epoxy package.
- Due to its clear epoxy, the device is sensitive to near and infrared radiation.

Package Dimensions in mm



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010 $^{\prime\prime}$) unless otherwise noted.

Figure 1. INL-5APD80 Package Dimensions



Absolute Maximum Rating at 25°C

Symbol	Symbol Parameters		Units	Notes
VR	Reverse Voltage	32	V	1
Topr	Operating Temperature	-40~+80	$^{\circ}$	
Tstg	Storage Temperature	-40~+85	$^{\circ}$	
Tsol	Tsol Soldering Temperature		°C	2
PD	Total Power Dissipation	150	mW	

Notes

1. Test conditions: IR=100µA, Ee=0mW/cm₂.

2. Soldering time ≤ 5 seconds.

Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Тур	Max	Units
λD	Rang of Spectral Bandwidth		400	-	1100	nm
λP	Wavelength of Peak Sensitivity		-	850		nm
VBR	Reverse Breakdown Voltage	E _e =0mW/cm ₂ IR=100uA	30	170	-	V
Voc	Open-Circuit Voltage	Ee=1mW/cm ² λ _P =850nm	-	0.4	-	V
Isc	Short-Circuit Current	Ee=1mW/cm² λ _P =850nm	-	35	-	uA
lσ	Dark Current	Ee=0mW/cm ² VR=10V	-	5	30	nA
lι	Reverse Light Current	Ee=1mW/cm ² λ _P =850nm, VR=5V	20	35	-	uA
t r	Rise Time	V _R =10V,	-	45	-	uS
tf	Fall Time	RL=100Ω	-	45	-	uS
Ст	Transition Capacitance	E _e =0mW/cm ² f=1MHz, VR=5V		18		pF
2θ1/2	Receiving Angle	IF=20mA		80		Deg.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection

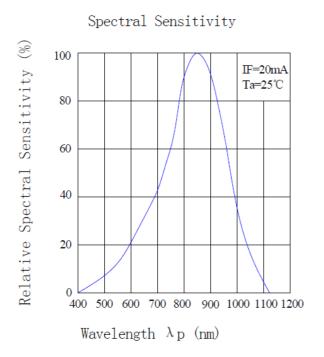


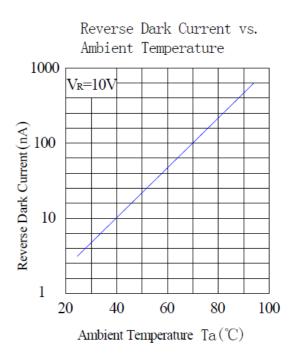
The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

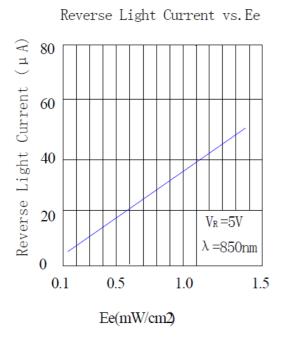
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

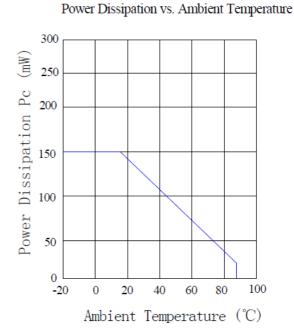


Typical Characteristic Curves





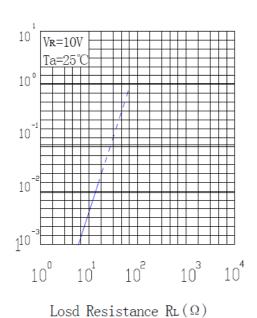






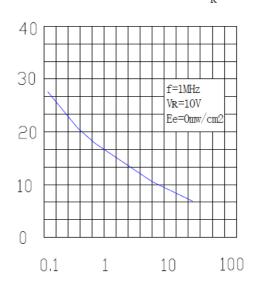
Rasponse Time vs. Losd Resistance

Rasponse Time tr, tf(us)



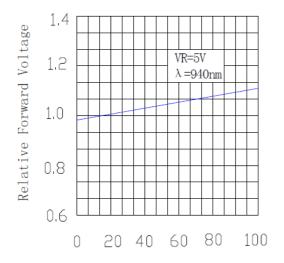
Terminal Capacitance vs. Reverse voltage

Terminal CapacitanceCt(pF)



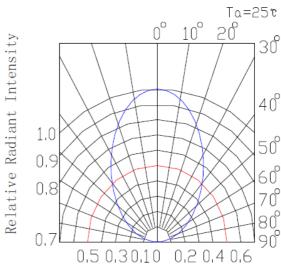
Reverse voltage (V)

Relative Reverse Light Current vs. Ambient Temperatyre(°C)



 ${\it Tamb-Ambient\ Temperature\ (^{\circ}\!C)}$

Relative Radiant Intensity vs. Angular Displacement

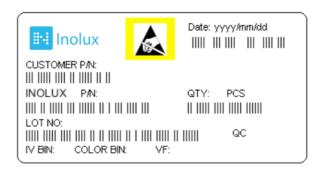




Ordering Information

Product	Symbol	Parameters	Test conditions	Min	Тур	Max	Units	Orderable Part Number
INL-5APD80	IL	Reverse Light Current	Ee=1mW/cm ² λ _P =850nm, VR=5V	20	35	-	uA	INL-5APD80

Label Specifications



Inolux P/N:

ı	N	L	-	5	Α	-	PD	8	0	Х	Х	Х	Х
				Pacl	kage	Lens	Color	View A	Angle			mized p-off	
	Inolux Lamp Typ	e		5 <i>A</i> stan 5n		(Blank) = clear	PD = Photo Diode	80 = 80) deg.				

Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Date	Serial	
Tracker		Year (2017, 2018,)				Date	Serial



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
recondition	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability	10/1/22/0	And CNS-5068	Tinning speed: 2.5+0.5cm/s
Coldciability		And ONO 3000	Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to		0110 0001	Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
boldoning node			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test	1 4, 1, 16, 6	0.10 1.020	85°C/ 60%R.H. for 168hrs
operating in a tool			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature	1 47 17 167 5	0205 / 1101 5	Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature			IF=20mA
bias			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
		IEC 68-2-14, Nb	15min
Temperature		, .	Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-24-2019
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